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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Multiple sheets used when necessary) SHEET 1 OF 1	Int'l Application No.	PG 2004/008749
	Int'l Filing Date	June 22, 2004
	First Named Inventor	Koichi MIKAMI
	Art Unit	Unknown 2821
	Examiner	Unknown shih-liao cha
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U.S. PATENT DOCUMENTS					
Examiner Initials	Cite No.	Document Number Number - Kind Code (if known) Example: 1,234,567 B1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear
ce	1.	6,281,858 858	08/28/01	TRW Inc. Jenneth et al.	

FOREIGN PATENT DOCUMENTS						
Examiner Initials	Cite No.	Foreign Patent Document Country Code-Number-Kind Code Example: JP 1234567 A1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	T'
ce	2.	JP 63-138803	06/10/88	Tsukiji, et al.	(English Abstract Only)	X
ce	3.	JP 04-048282	02/18/92	NEC Corp.	(English Abstract Only)	X
ce	4.	JP 08-053735	02/25/94	NHK Spring Co., Ltd.	(English Abstract Only)	X
ce	5.	JP 10-022721	01/23/98	Mitsubishi Electric Corp.	(English Abstract Only)	X
ce	6.	JP 2001-196838	07/19/01	TRW Inc.	(English Abstract Only)	X
ce	7.	JP 2002-135031	05/10/02	Mitsubishi Electric Corp.	(English Abstract Only)	X
ce	8.	EP 1 102 349	05/23/01	Northrop Grumman Corp.		

NON PATENT LITERATURE DOCUMENTS			
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T'

Examiner Signature	shih-liao cha	Date Considered	11/3/06
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